

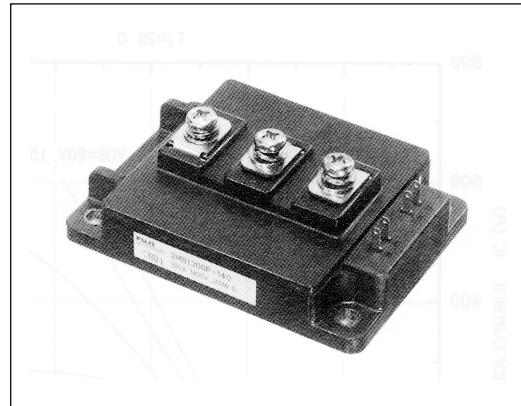
1200V / 300A 2 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

**■ Maximum ratings and characteristics****● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)**

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V_{CES}	1200	V
Gate-Emitter voltage	V_{GES}	± 20	V
Collector current	Continuous $T_c=25^\circ\text{C}$	IC	A
		400	A
	$T_c=80^\circ\text{C}$	300	A
1ms		IC pulse	A
	$T_c=25^\circ\text{C}$	800	A
		600	A
	$T_c=80^\circ\text{C}$	-IC	A
		300	A
1ms	-IC pulse	600	A
Max. power dissipation	P_c	2500	W
Operating temperature	T_j	+150	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +125	$^\circ\text{C}$
Isolation voltage *1	V_{is}	AC 2500 (1min.)	V
Screw torque	Mounting *2	3.5	N·m
	Terminals *2	4.5	N·m

*1 : All terminals should be connected together when isolation test will be done

*2 : Recommendable value : Mounting 2.5 to 3.5 N·m(M5 or M6)
Terminals 3.5 to 4.5 N·m(M6)

● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I_{CES}	—	—	3.0	$V_{GE}=0\text{V}$, $V_{CE}=1200\text{V}$	mA
Gate-Emitter leakage current	I_{GES}	—	—	0.6	$V_{CE}=0\text{V}$, $V_{GE}=\pm 20\text{V}$	μA
Gate-Emitter threshold voltage	$V_{GE(\text{th})}$	5.5	7.2	8.5	$V_{CE}=20\text{V}$, $I_c=300\text{mA}$	V
Collector-Emitter saturation voltage	$V_{CE(\text{sat})}$	—	2.3	2.6	$T_c=25^\circ\text{C}$	V
		—	2.8	—	$T_c=125^\circ\text{C}$	
Input capacitance	C_{ies}	—	36000	—	$V_{GE}=0\text{V}$ $V_{CE}=10\text{V}$ $f=1\text{MHz}$	pF
Output capacitance	C_{oes}	—	7500	—		
Reverse transfer capacitance	C_{res}	—	6600	—		
Turn-on time	t_{on}	—	0.35	1.2	$V_{cc}=600\text{V}$ $I_c=300\text{A}$ $V_{GE}=\pm 15\text{V}$ $R_g=2.7\text{ ohm}$	μs
		—	0.25	0.6		
		—	0.1	—		
Turn-off time	t_{off}	—	0.45	1.0		
		—	0.08	0.3		
Forward on voltage	V_F	—	2.3	3.0	$T_j=25^\circ\text{C}$	V
		—	2.0	—	$T_j=125^\circ\text{C}$	
Reverse recovery time	t_{rr}	—	—	0.35	$I_F=300\text{A}$	μs

● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	$R_{th(j-c)}$	—	—	0.05	IGBT	$^\circ\text{C}/\text{W}$
	$R_{th(j-c)}$	—	—	0.10	Diode	$^\circ\text{C}/\text{W}$
	$R_{th(c-f)}^*{}^2$	—	0.0167	—	the base to cooling fin	$^\circ\text{C}/\text{W}$

*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound